

Vishay Siliconix

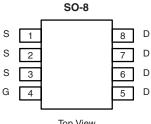
RoHS

COMPLIANT

HALOGEN FREE

P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
- 30	0.0098 at V _{GS} = 10 V	- 19.7	27 nC			
	0.0165 at V _{GS} = 4.5 V	- 15.2	27110			



Top View

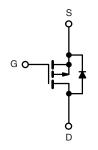
Ordering Information: Si4425DDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 • Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested ٠

APPLICATIONS

- Load Switches
- Notebook PCs
- Desktop PCs



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \text{ °C}$, unless otherwise noted						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	- 30	V		
Gate-Source Voltage		V _{GS}	± 20	V		
	T _C = 25 °C		- 19.7			
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	I _D	- 15.7			
Continuous Drain Current $(T_J = 150^{\circ}C)$	T _A = 25 °C		- 13 ^{b, c}			
	T _A = 70 °C		- 10.4 ^{b, c}	А		
Pulsed Drain Current		I _{DM}	- 50			
Continous Source-Drain Diode Current	T _C = 25 °C	- I _S	- 4.7			
	T _A = 25 °C		- 2.1 ^{b, c}			
	T _C = 25 °C		5.7			
Maximum Power Dissipation	T _C = 70 °C	– P _D	3.6	w		
	T _A = 25 °C		2.5 ^{b, c}	vv		
	T _A = 70 °C		1.6 ^{b, c}			
Operating Junction and Storage Temperatur	e Range	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	35	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	18	22	- C/W		

Notes:

a. Based on $T_C = 25$ °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 85 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					<u> </u>		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 20		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i _D = - 250 μA		4.9			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 1.2		- 2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
	I _{DSS}	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	μA	
Zero Gate Voltage Drain Current		V_{DS} = - 30 V, V_{GS} = 0 V, T_{J} = 55 °C			- 5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 5 V, V_{GS} = - 10 V	- 30			Α	
	D	V _{GS} = - 10 V, I _D = - 13 A	0.0081 0.00		0.0098		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 10 A		0.0137	0.0165	5 Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 13 A		40		S	
Dynamic ^b							
Input Capacitance	C _{iss}			2610			
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		460		pF	
Reverse Transfer Capacitance	C _{rss}			395			
Total Gate Charge	Qg	V_{DS} = - 15 V, V_{GS} = - 10 V, I_{D} = - 13 A		53	80	nC	
				27	41		
Gate-Source Charge	Q _{gs}	V_{DS} = - 15 V, V_{GS} = - 4.5 V, I_{D} = - 13 A		8			
Gate-Drain Charge	Q _{gd}			13			
Gate Resistance	R _g	f = 1 MHz	0.4	2.1	4.2	Ω	
Turn-On Delay Time	t _{d(on)}			52	78	- ns	
Rise Time	t _r	V_{DD} = - 15 V, R_L = 1.5 Ω		41	62		
Turn-Off Delay Time	t _{d(off)}	$\rm I_D \cong$ - 10 A, $\rm V_{GEN}$ = - 4.5 V, $\rm R_g$ = 1 Ω		36	54		
Fall Time	t _f			15	25		
Turn-On Delay Time	t _{d(on)}			12	20		
Rise Time	t _r	V_{DD} = - 15 V, R_L = 1.5 Ω		9	15		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 10 A, V_GEN = - 10 V, R_g = 1 Ω		42	63		
Fall Time	t _f			9	15		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	۱ _S	$T_{C} = 25 \ ^{\circ}C$			- 4.7	Δ	
Pulse Diode Forward Current	I _{SM}				- 50	A	
Body Diode Voltage	V _{SD}	I _S = - 10 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			20	30	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	$\frac{Q_{rr}}{t_a}$ I _F = - 10 A, dI/dt = 100 A/µs, T _J = 25 °C		10	20	nC	
Reverse Recovery Fall Time	t _a			10		ns	
Reverse Recovery Rise Time	t _b			9			

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

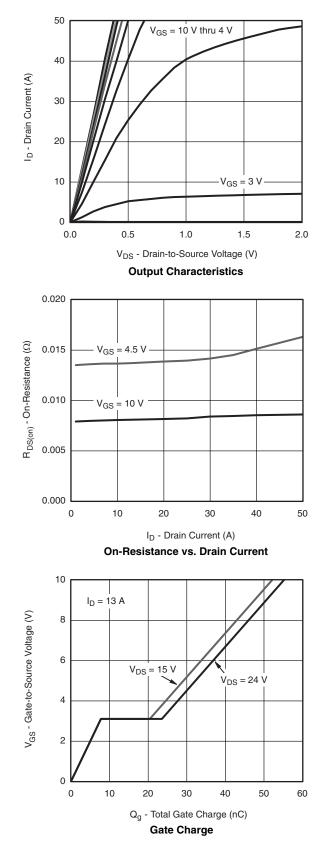
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

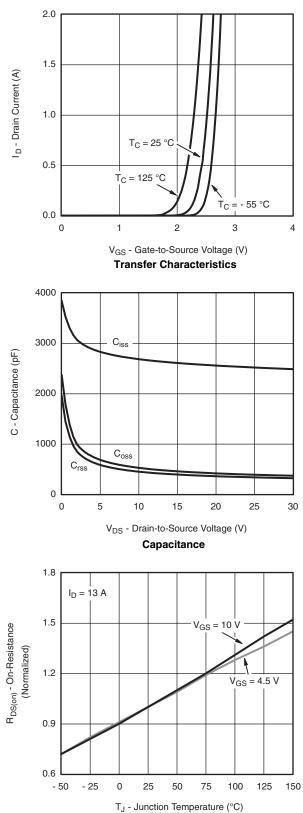


Si4425DDY

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





On-Resistance vs. Junction Temperature

Si4425DDY

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VISHAY

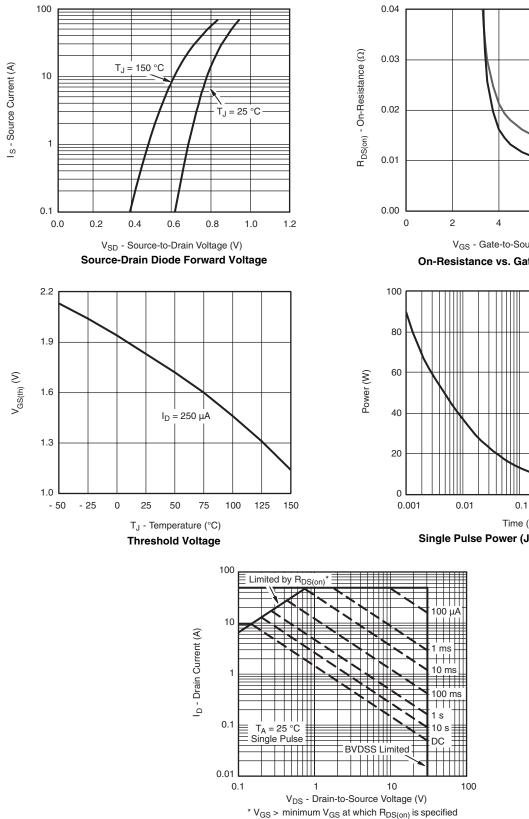
 $T_J = 125 \ ^\circ C$

 $T_J = 25 \ ^{\circ}C$

10

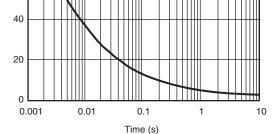
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



V_{GS} - Gate-to-Source Voltage (V) **On-Resistance vs. Gate-to-Source Voltage**

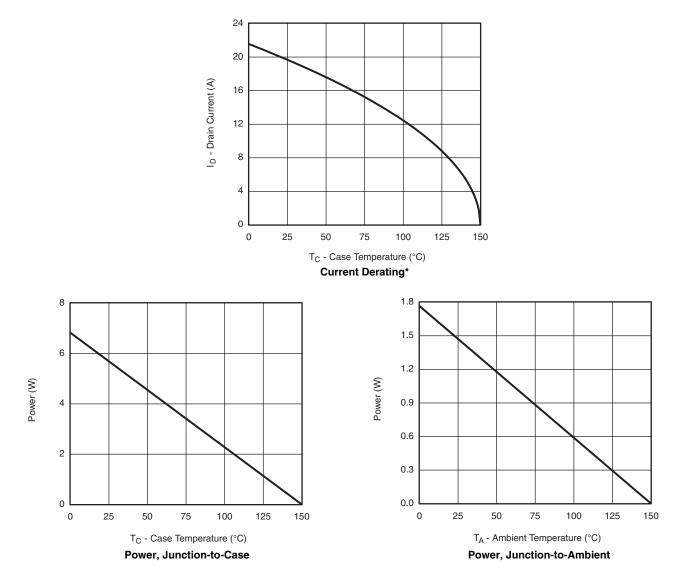
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Single Pulse Power (Junction-to-Ambient)



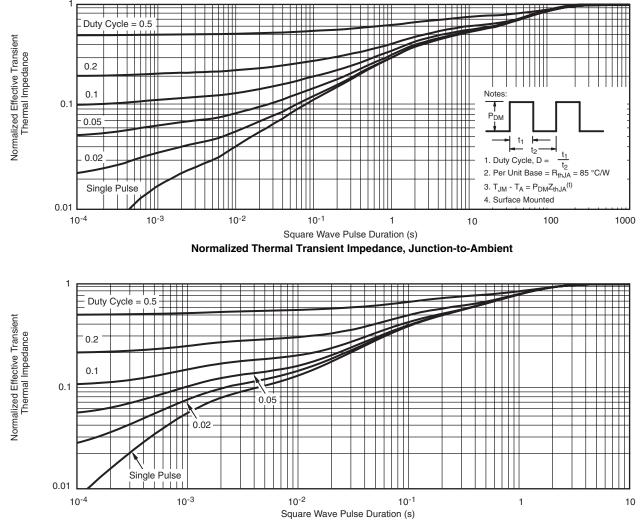
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?64732.



Package Information

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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